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Kim et al.

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(54) **FACSIMILE**

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D544,869 S 6/2007 Kang et al.

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(**) Term: **14 Years**

(57) **CLAIM**

(21) Appl. No.: **29/293,227**

The ornamental design for a facsimile, as shown and described.

(22) Filed: **Nov. 9, 2007**

(51) **LOC (8) Cl.** **16-03**

(52) **U.S. Cl.** **D14/467**; D14/468

(58) **Field of Classification Search** D14/462–471;
D18/36–41; 358/400–404
See application file for complete search history.

DESCRIPTION

FIG. 1 is a top front perspective view of a facsimile showing our new design;

FIG. 2 is a front elevational view thereof;

FIG. 3 is a rear elevational view thereof;

FIG. 4 is a left side elevational view thereof;

FIG. 5 is a right side elevational view thereof;

FIG. 6 is a top plan view thereof; and,

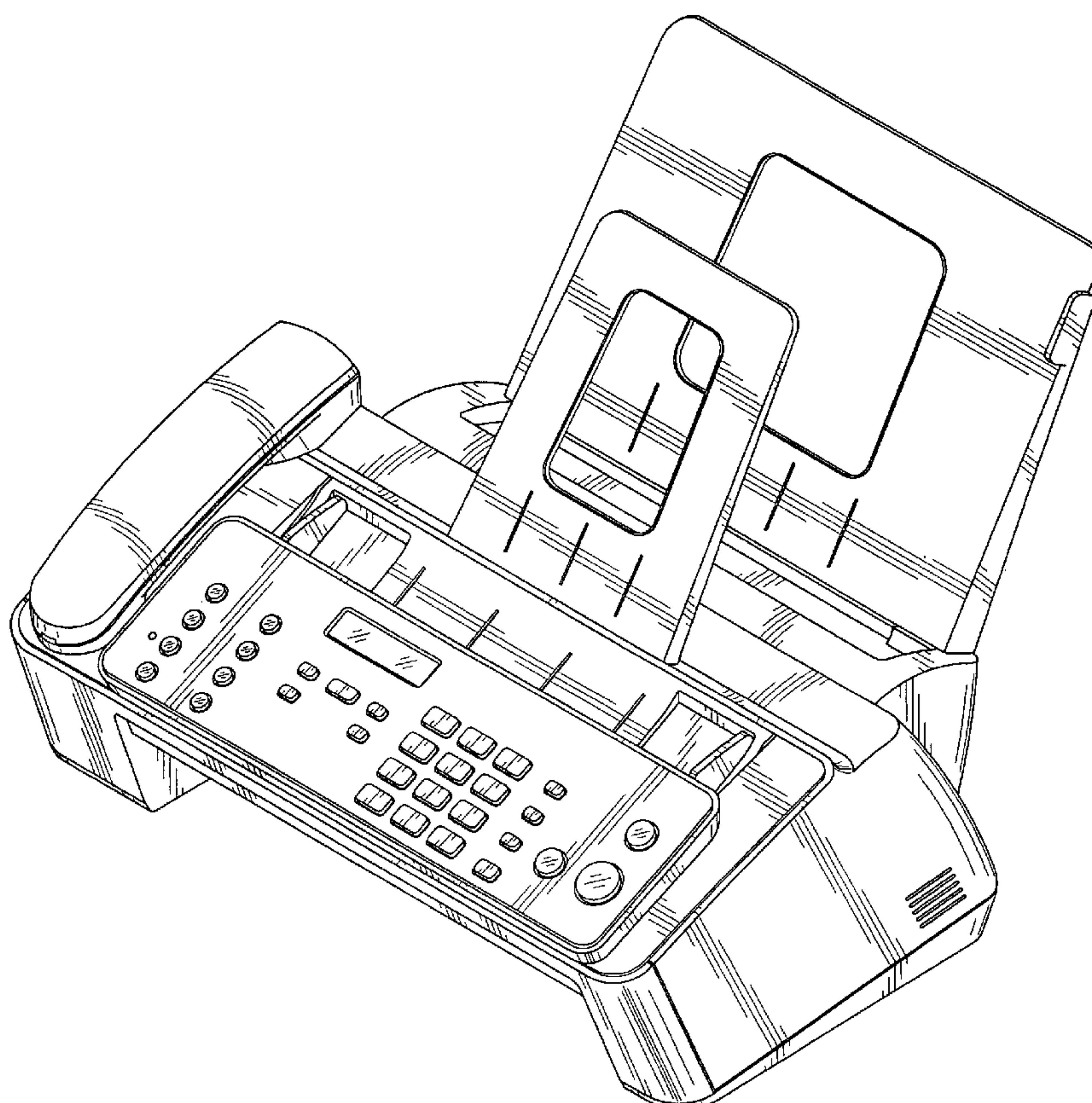
FIG. 7 is a bottom plan view thereof.

(56) **References Cited**

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1 Claim, 5 Drawing Sheets



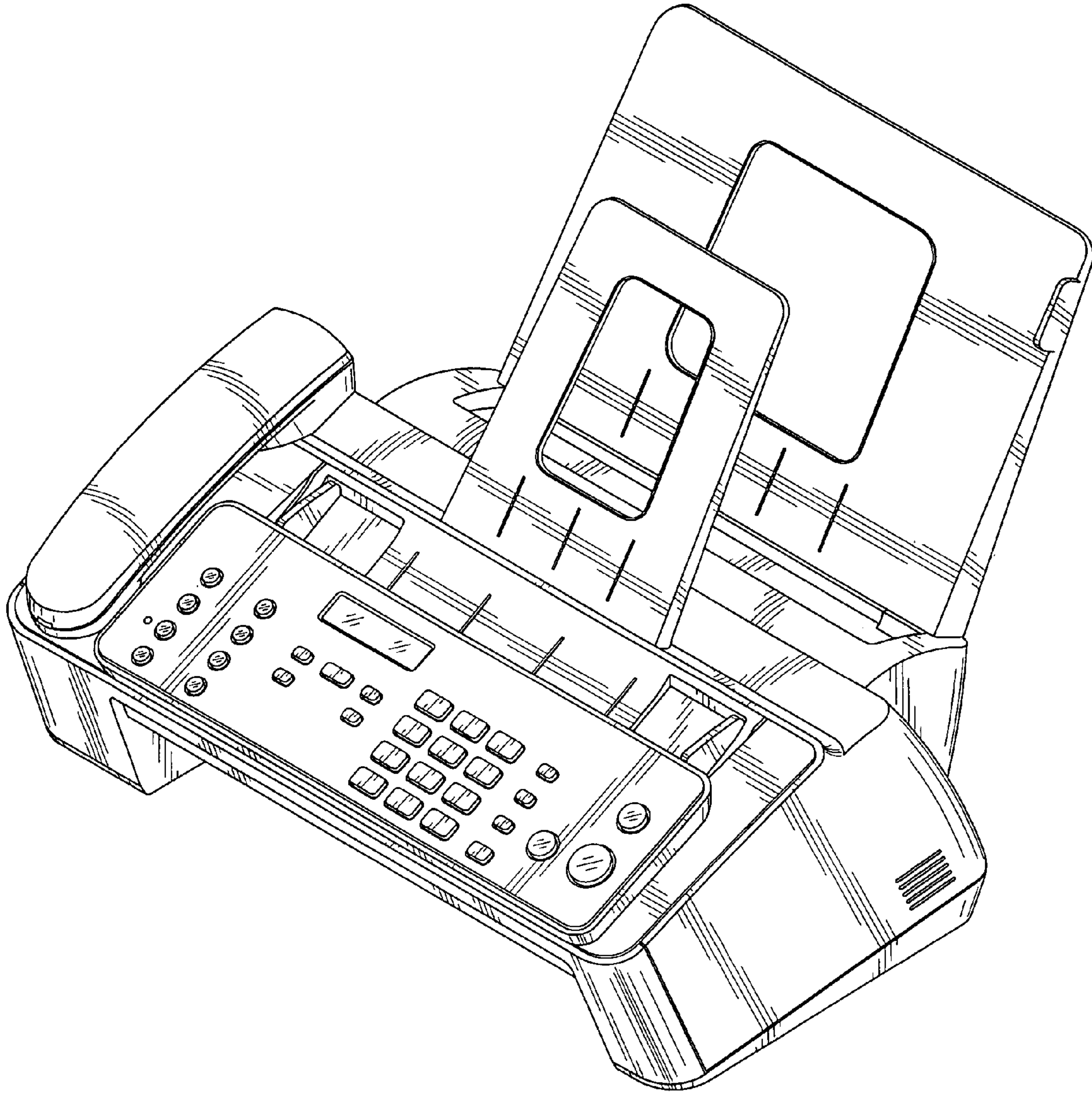


FIG.1

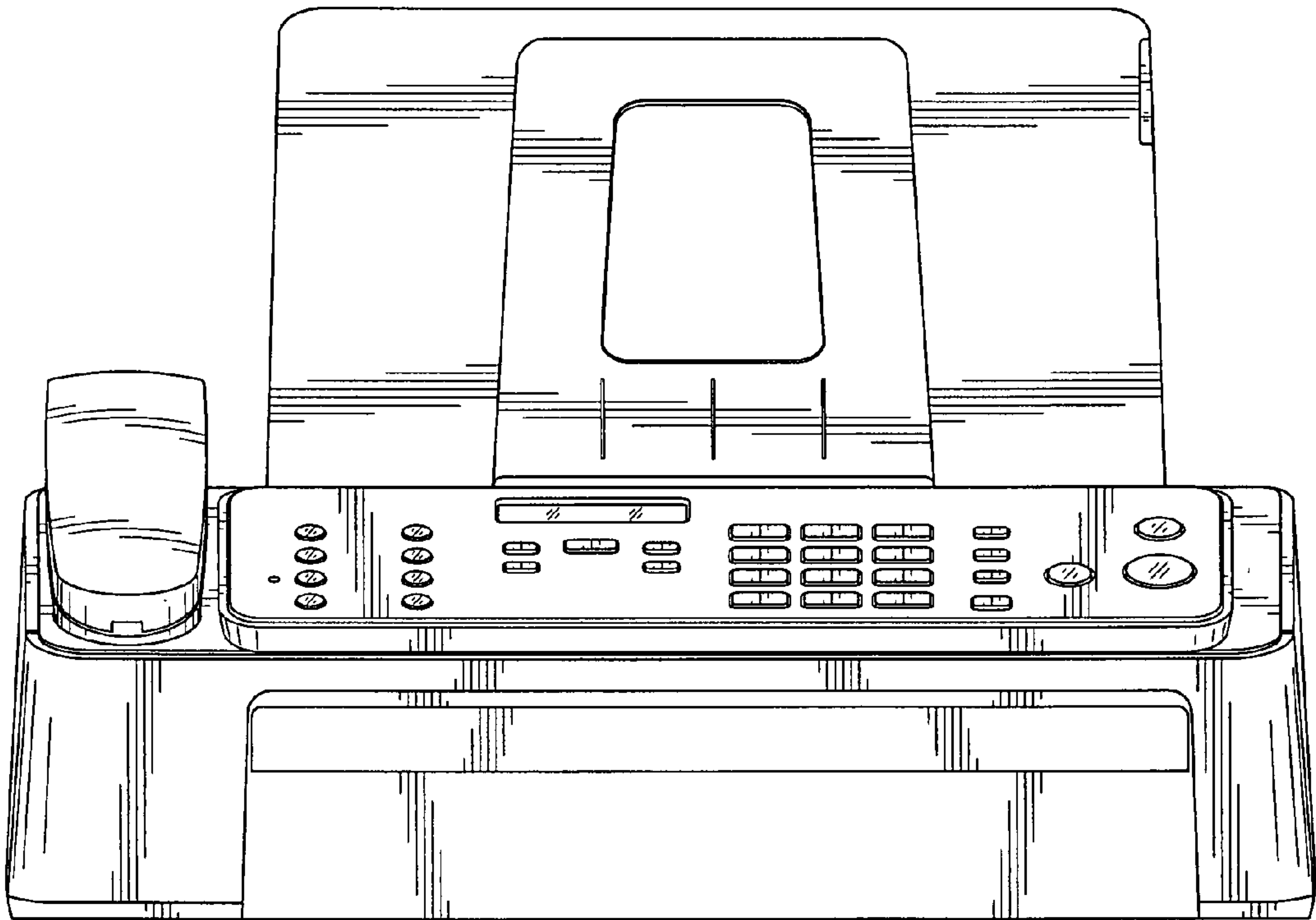


FIG. 2

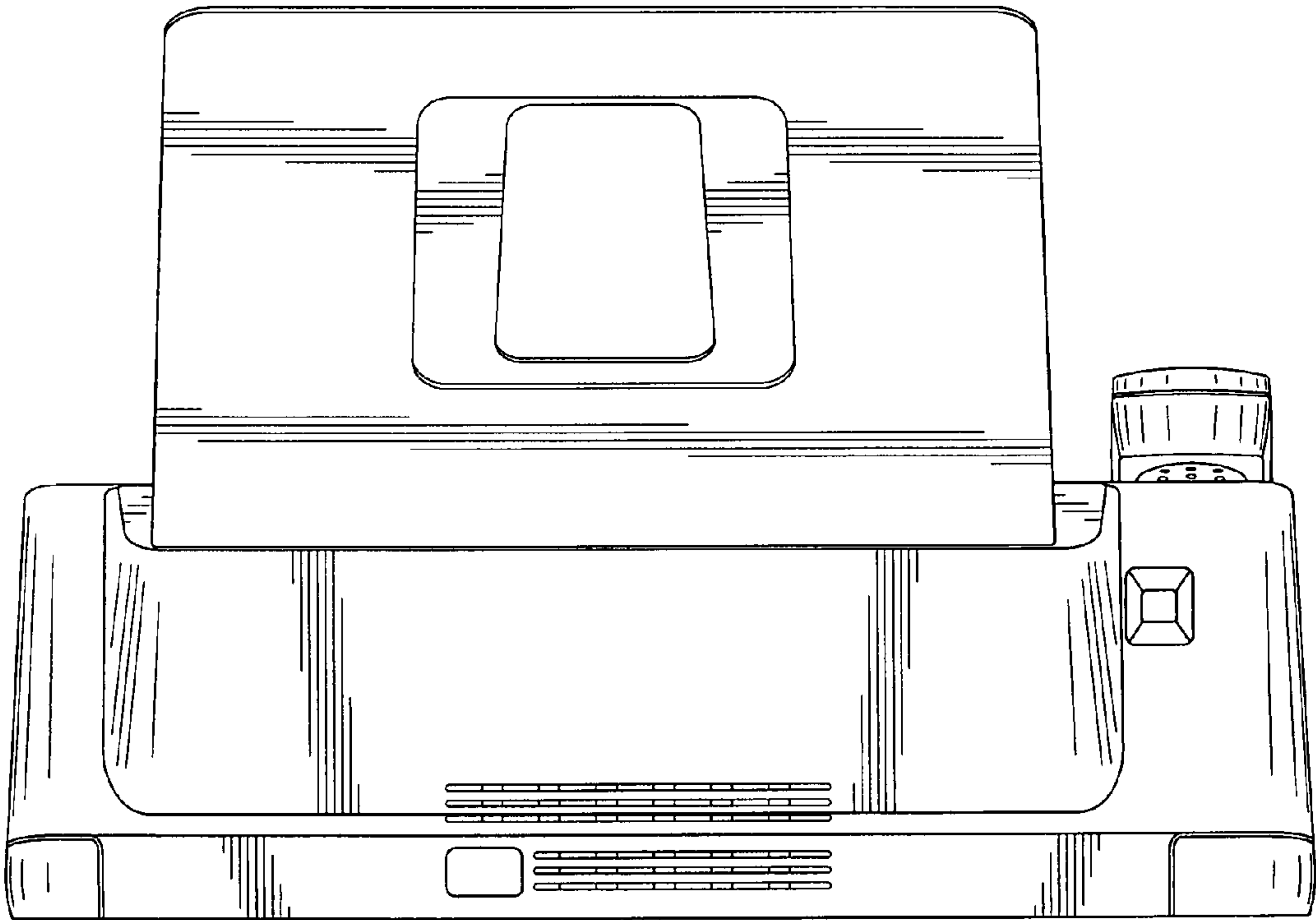


FIG. 3

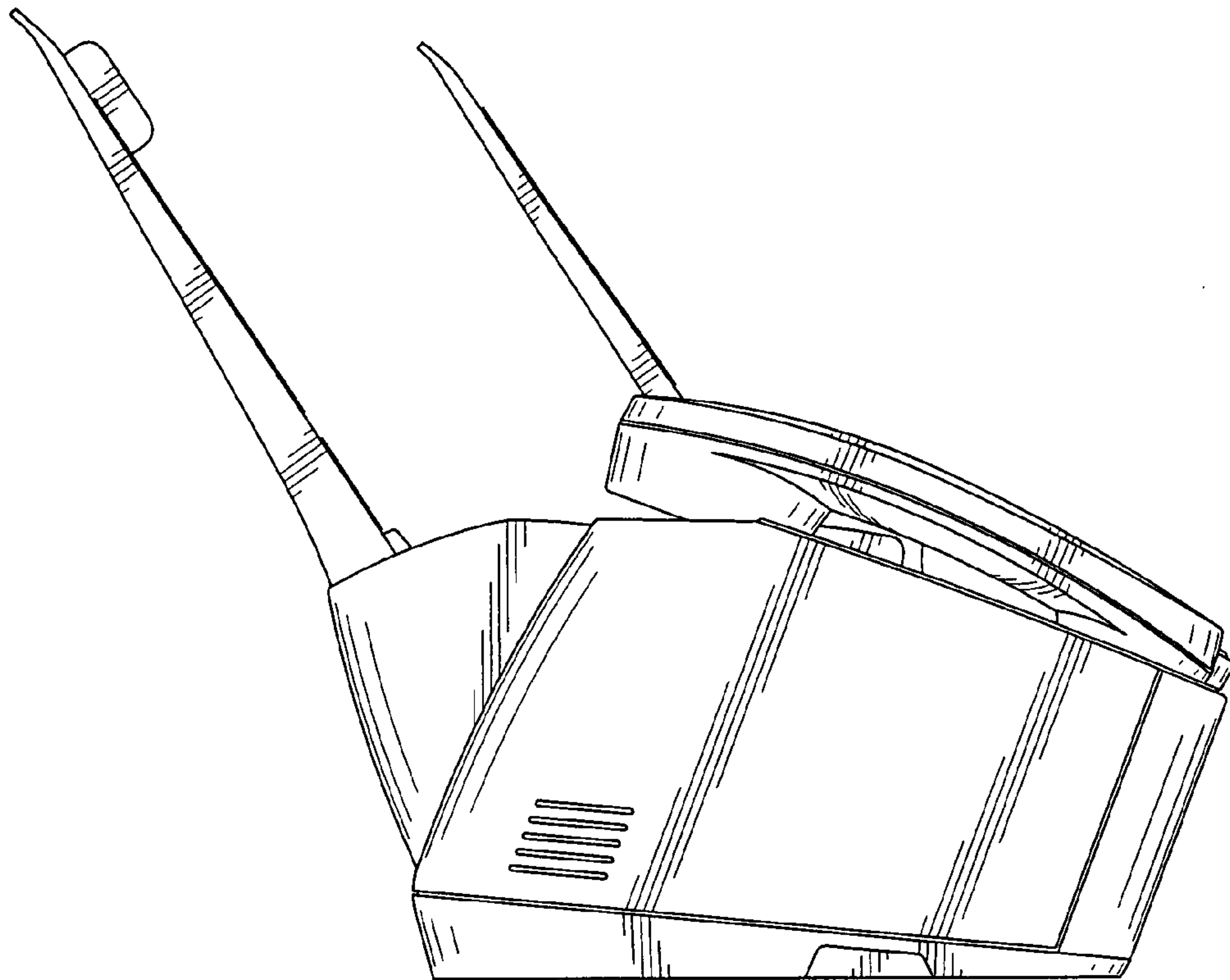


FIG. 4

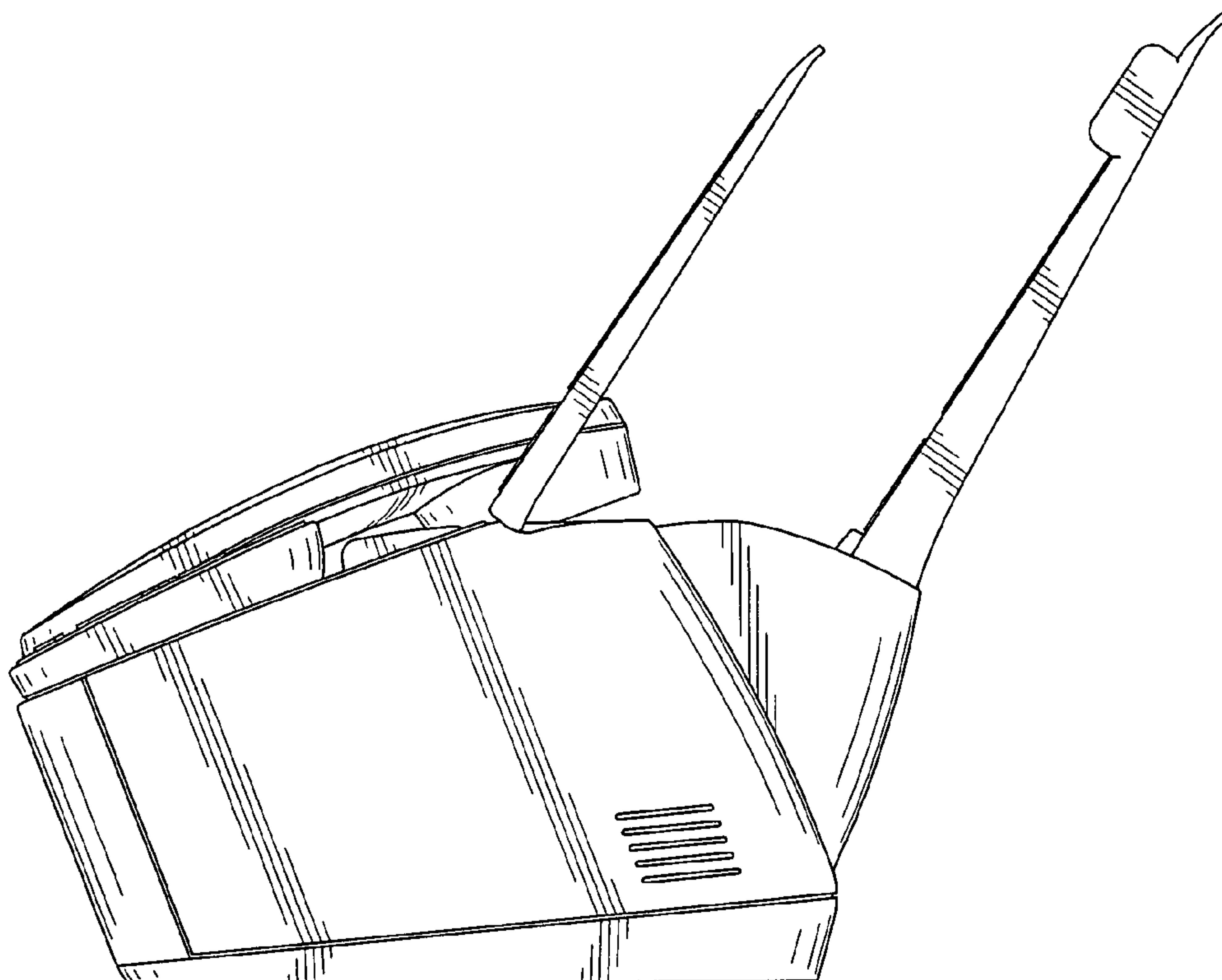


FIG. 5

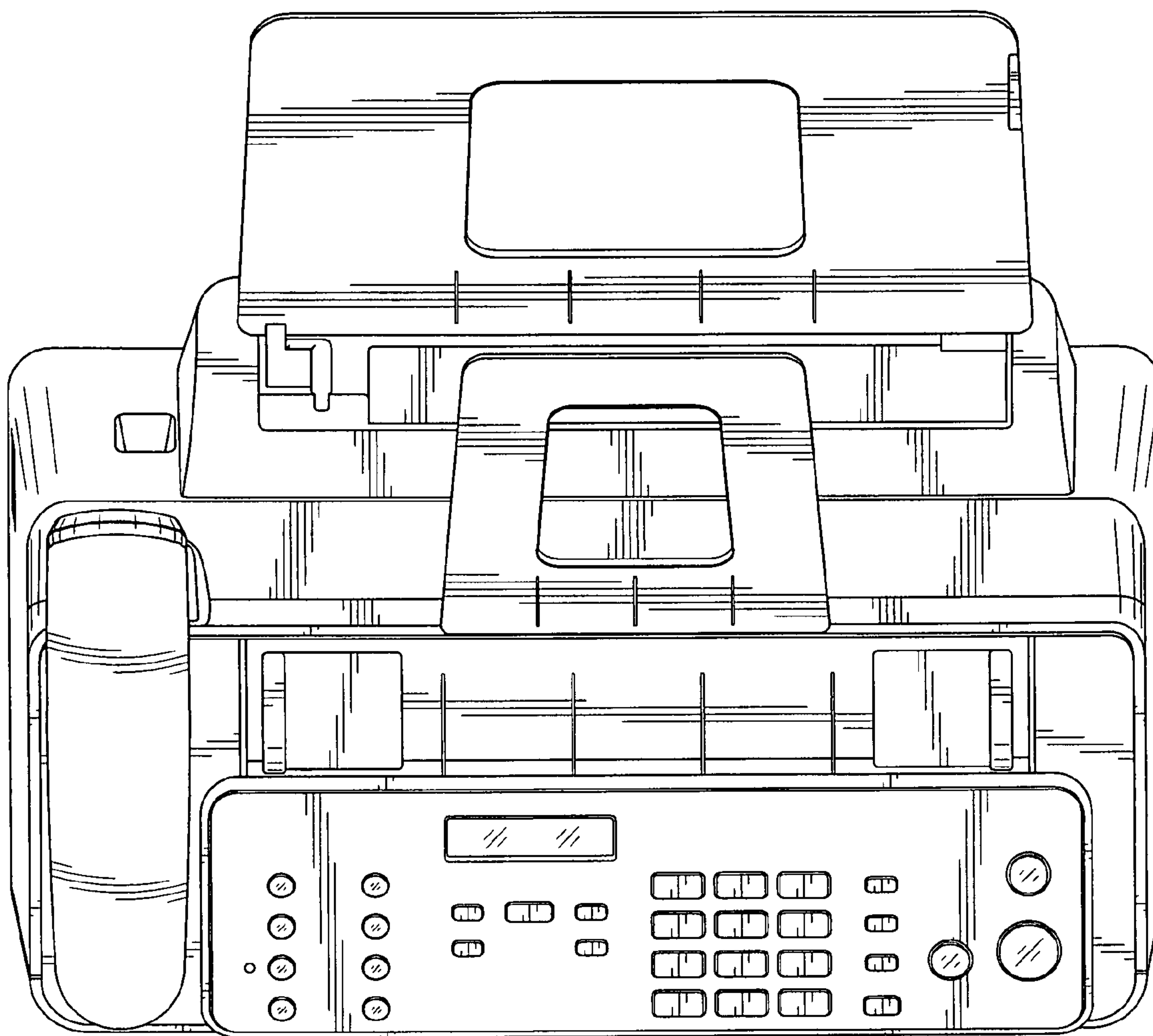


FIG.6

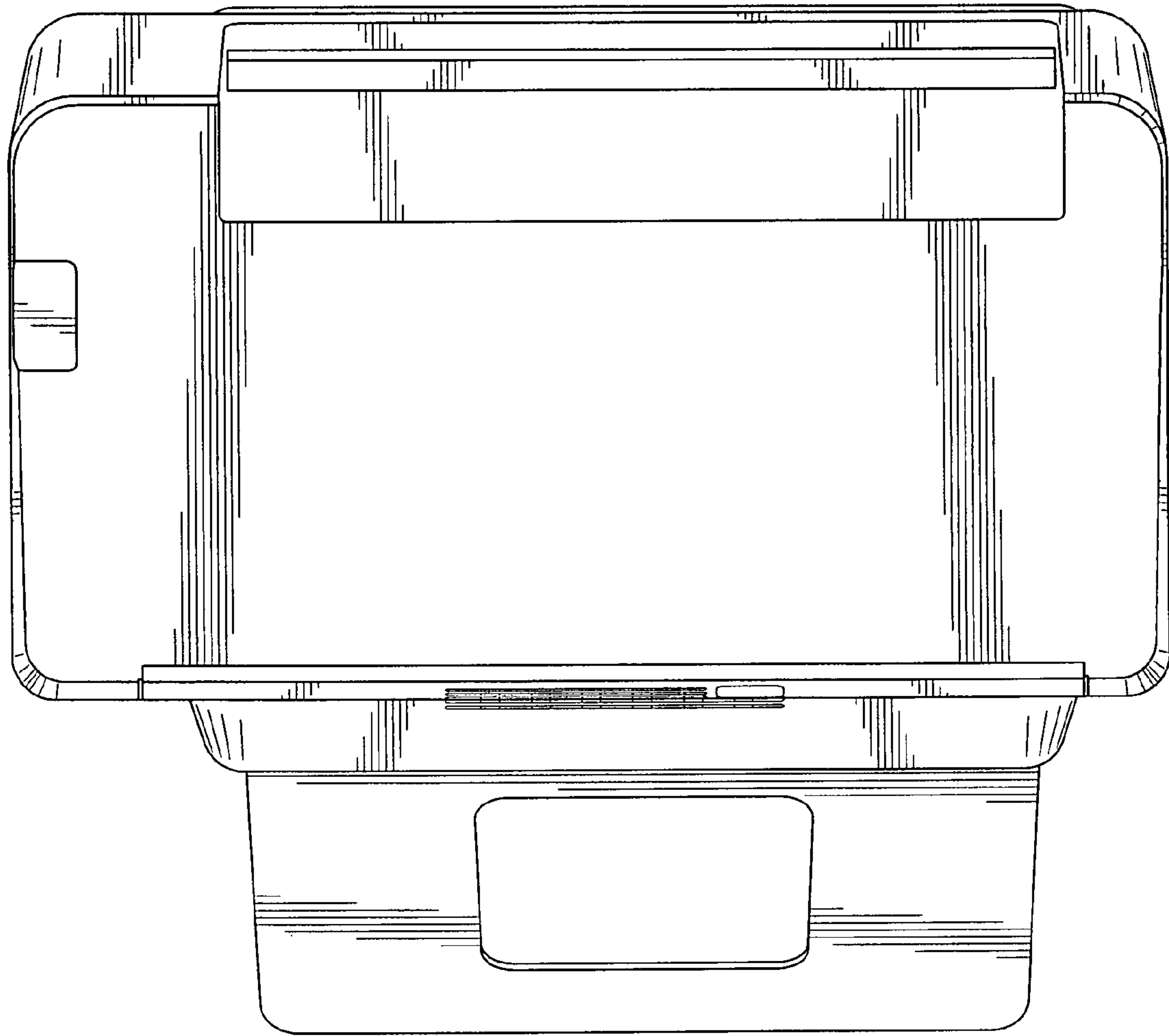


FIG. 7